

Special Issue

Advances in Bioprinting

Message from the Guest Editor

3D bioprinting has emerged as one of the leading manufacturing platforms for fabrication of highly complex 3D tissues and/or organs. The field of 3D bioprinting has advanced rapidly over the last few years, notably in the advances of bioprinting technologies and the development of novel printable bio-inks and printing strategies. *Applied Sciences*—“Advances in Bioprinting” publishes research that addresses the needs and goals of 3D bioprinting.

Guest Editor

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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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